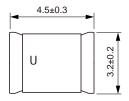


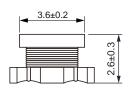
SMD Power Inductor Size 4532

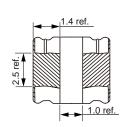


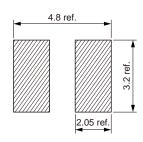
- j
- O ' ') #) # '
- **-** 7
- **8**

Dimensions: [mm] Land Pattern: [mm]









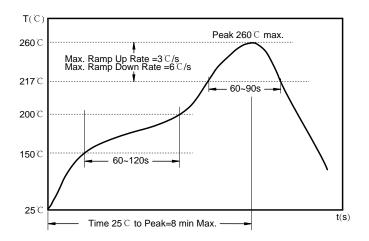
Electrical Properties:

Part I	No	Inductance (μΗ)	Test Conditions	Tolerance	DC Resistance MAX. (Ω)	SRF Min. (MHz)	Saturation Current Max. (A)
‡@	k U		U =- †				
‡@	k U		U =- †				
‡@	k U		U =- †				·
‡@	k U		U =- †				·
‡@	М		U =- †				
‡ @	М		U =- †				
‡@	М		U =- †				·
‡ @	М		U =- †				·
‡ @	М		U =- †				·
‡ @	М		U =- †				
‡ @	М		U =- †				
‡ @	М		U =- †				
‡ @	М	·	U =- †				·
‡ @	М		№- †				
‡ @	М		№- †				
‡ @	М		M- †				

Saturation Current will cause L to drop approximately 10%



Soldering Reflow:



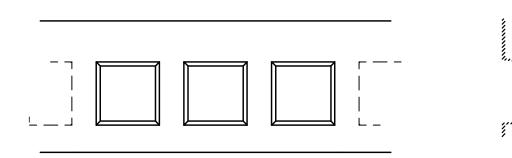
Preheat condition: 150 ~200 $^{\circ}\text{C}$ / 60~120 sec.

Allowed time above 217°C: 60~90 sec.

Max temperature: 260 ℃.

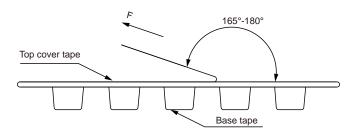
Packaging Information:

Tape Dimension:



Series	A0	B0	D	P0	P1	W	K0	E	T
	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)
WI453	3.45± 0.1	4.70± 0.1	1.5± 0.1	4.0± 0.1	8.0± 0.1	12.0± 0.3	3.15± 0.1	1.75± 0.1	0.40± 0.05

Peel force of top cover tape:



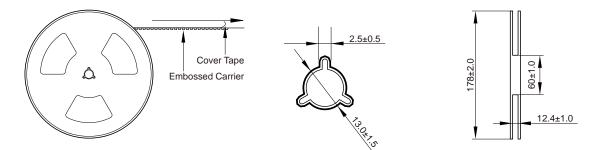
The peel force of top cover tape shall be between 0.3 to 1.17~N

Product Marking:

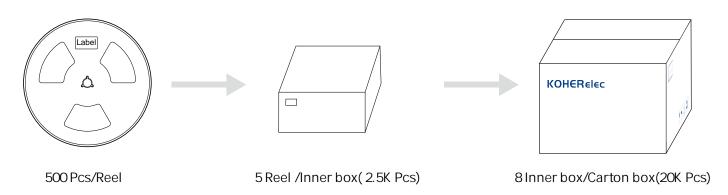
Marking Printing Inductance)



Reel Dimension: [mm]



Packaging Quantity:



Cautions and Warnings:

Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer
 does.As a result customer shall be responsible for checking and confirming whether Koher product with the
 performance described in the product specification is suitable for using in customer's particular application or
 not.